

Title (en)
THIN STRIPS OR FOILS OF AL-FE-SI ALLOY

Title (de)
DÜNNE BÄNDER ODER BLECHE AUS EINER AL-FE-SI-LEGIERUNG

Title (fr)
FEUILLES OU BANDES MINCES EN ALLIAGE AL-FE-SI

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Application
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Abstract (en)
[origin: US2006213590A1] The invention relates to a thin strip or foil, having a thickness of 6 to 200 μm , preferably, of 6 to 50 μm , and composed of an alloy containing (in weight %) Si: 1.0 to 1.5, Fe: 1.0 to 1.5, Cu <0.2, Mn <0.1, other elements <0.05 each up to a total <0.15, the remainder being Al. The annealed thin strip or foil has a tensile strength $R_{\text{m}} > 110 \text{ MPa}$ for a thickness $> 9 \mu\text{m}$ and $> 100 \text{ MPa}$ for a thickness of 6 to 9 μm , and an elastic limit $R_{\text{e}0.2} > 70 \text{ MPa}$. Preferably, said alloy has a silicon content of 1.1 to 1.3% and an iron content of 1.0 to 1.2%. The aforementioned thin strips or foils may be used especially for the production of multilayer composites, overcaps for bottles or aluminium wrappings.

IPC 1-7
C22C 1/00

IPC 8 full level
C22C 21/00 (2006.01); **C22C 21/02** (2006.01); **C22F 1/04** (2006.01); **C22F 1/043** (2006.01)

IPC 8 main group level
C22C (2006.01)

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